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Dual N-Channel PowerTrench[®] MOSFET Q1: 30 V, 201 A, 1.25 m Ω Q2: 30 V, 201 A, 1.25 m Ω

Features

Q1: N-Channel

- Max r_{DS(on)} = 1.25 mΩ at V_{GS} = 10 V, I_D = 35 A
- Max r_{DS(on)} = 1.5 mΩ at V_{GS} = 4.5 V, I_D = 32 A

Q2: N-Channel

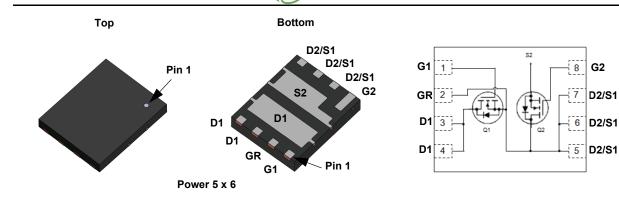
- Max r_{DS(on)} = 1.25 mΩ at V_{GS} = 10 V, I_D = 35 A
- Max r_{DS(on)} = 1.5 mΩ at V_{GS} = 4.5 V, I_D = 32 A
- Ideal for Flexible Layout in Primary Side of Bridge Topology
- 100% UIL Tested
- Kelvin High Side MOSFET Drive Pin-out Capability
- RoHS Compliant

General Description

This device includes two 30V N-Channel MOSFETs in a dual power (5 mm X 6 mm) package. HS source and LS drain internally connected for half/full bridge, low source inductance package, low $r_{\text{DS(on)}}/\text{Qg}$ FOM silicon.

Applications

- POL Synchronous Dual
- One Phase Motor Half Bridge
- Half/Full Bridge Secondary Synchronous Rectification



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Parameter			Q1	Q2	Units
V _{DS}	Drain to Source Voltage			30	30	V
V _{GS}	Gate to Source Voltage			±20	±20	V
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	201	201	
	-Continuous	T _C = 100 °C	(Note 5)	127	127	•
D	Drain Current -Continuous	T _A = 25 °C		35 ^{1a}	35 ^{1b}	A
	-Pulsed		(Note 4)	1047	1047	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	661	661	mJ
D	Power Dissipation	T _C = 25 °C		78	78	W
P _D	Power Dissipation	T _A = 25 °C		2.2 ^{1a}	2.2 ^{1b}	vv
T _J , T _{STG}	Operating and Storage Junction Temperature F	Range		-55 to	+150	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	1.6	1.6	°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient	55 ^{1a}	55 ^{1b}	C/VV

Package Marking and Ordering Information

Devic	e Marking	Device	Package	Reel Size	Tape Width	Quantity
FDI	MD8530	FDMD8530	Power 5 x 6	13 "	12 mm	3000 units

October 2015

FDMD8530 E
)ual
N-Channel
PowerTrench
[®] MOSFET

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Symbol	Parameter	Test Conditions	Туре	Min.	Тур.	Max.	Units
Off Cha	racteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I_D = 250 μ A, V _{GS} = 0 V	Q1 Q2	30 30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C	Q1 Q2		20 20		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V	Q1 Q2			1 1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V	Q1 Q2			±100 ±100	nA
On Chai	racteristics	•			•		
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, \ I_D = 250 \ \mu A$	Q1 Q2	1.0 1.0	1.5 1.5	3.0 3.0	V
A) /	Oata ta Cauraa Threahald Maltara		01		~		

♥ GS(th)	Cale to Cource Threshold Voltage	VGS - VDS, 1D - 200 μΑ	Q2	1.0	1.5	3.0	v
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C	Q1 Q2		-5 -5		mV/°C
		V _{GS} = 10 V, I _D = 35 A			0.77	1.25	mΩ
		V _{GS} = 4.5 V, I _D = 32 A	Q1 Q2		0.96	1.5	
r	Static Drain to Source On Resistance	V_{GS} = 10 V, I_{D} = 35 A, T_{J} = 125 °C			1.1	1.8	
DS(on)		V _{GS} = 10 V, I _D = 35 A			0.77	1.25	
		V _{GS} = 4.5 V, I _D = 32 A			0.96	1.5	
		V_{GS} = 10 V, I_{D} = 35 A, T_{J} = 125 °C			1.1	1.8	
0-0	Forward Transconductance	V _{DD} = 5 V, I _D = 35 A	Q1		259		S
9 _{FS}			Q2		259		5

Dynamic Characteristics

C _{iss}	Input Capacitance		Q1 02		7425 7425	10395 10395	pF
C _{oss}	Output Capacitance	V _{DS} = 15 V, V _{GS} = 0 V f = 1 MHz	Q2 Q1 Q2		2190 2190	3070 3070	pF
C _{rss}	Reverse Transfer Capacitance		Q1 Q2		2100 220 220	310 310	pF
R _g	Gate Resistance		Q1 Q2	0.1 0.1	1.9 1.9	3.8 3.8	Ω

Switching Characteristics

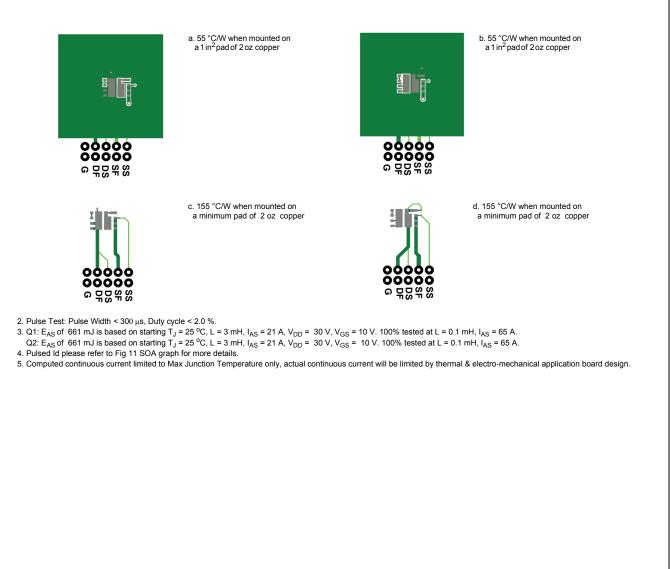
t _{d(on)}	Turn-On Delay Time			Q1 Q2	14 14	25 25	ns
t _r	Rise Time	V - 45 V L - 25	٨	Q1 Q2	13 13	24 24	ns ns
t _{d(off)}	Turn-Off Delay Time		V _{DD} = 15 V, I _D = 35 A V _{GS} = 10 V, R _{GEN} = 6 Ω	Q2 Q1 Q2	71 71	114 114	
t _f	Fall Time			Q1 Q2	21 21	34 34	ns
Q _{g(TOT)}	Total Gate Charge	V _{GS} = 0 V to 10 V	V _{GS} = 0 V to 10 V	Q1 Q2	106 106	149 149	nC
Q _{g(TOT)}	Total Gate Charge	V_{GS} = 0 V to 4.5 V		Q1 Q2	50 50	70 70	nC
Q _{gs}	Gate to Source Charge		[⊥] V _{DD} = 15 V, I _D =35 A	Q1 Q2	16 16		nC
Q _{gd}	Gate to Drain "Miller" Charge			Q1 Q2	13 13		nC

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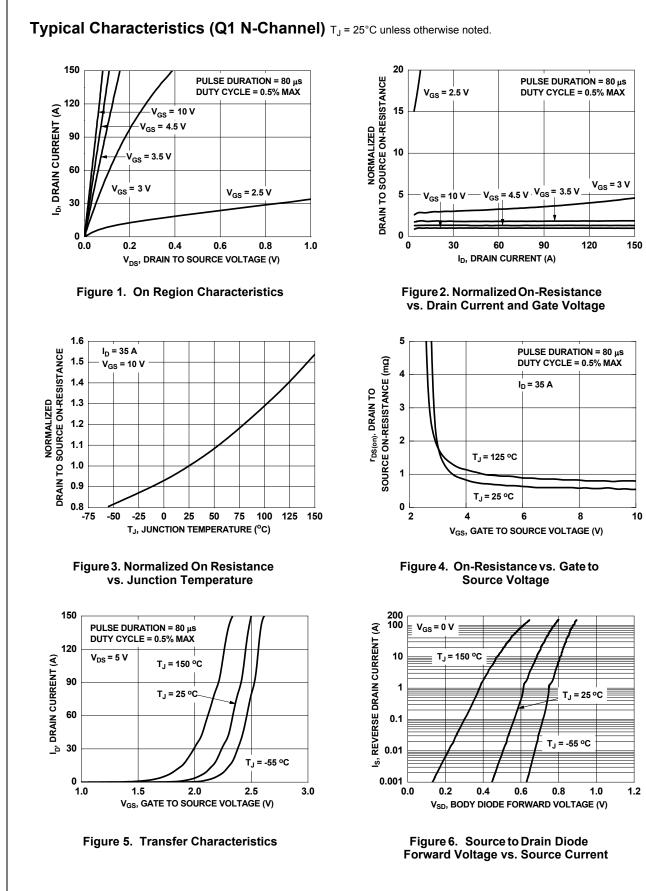
Symbol	Parameter	Test Conditions		Туре	Min	Тур	Max	Units
Drain-S	ource Diode Characteristics							
V _{SD}	Source to Drain Diode Forward Voltage	Diada Eaguard Valtage $V_{1} = 0 V_{1} = 25 A_{2}$	(Note 2)	Q1		0.8	1.3	V
V SD	Source to Drain Diode i orward voltage	VGS - 0 V, IS - 55 A	(11016 2)	Q2		0.8	1.3	v
V	Course to Drain Diado Forward Maltage	$\lambda = 0 \lambda + z = 0 \lambda$ (Nate 2)	(Note 2)	Q1		0.7	1.2	V
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2 A$	(INOLE Z)	Q2		0.7	1.2	v
+				Q1		54	87	20
۲r	Reverse Recovery Time	1 - 25 = 0 di/dt = 100 0/		Q2		54	87	ns
0	Boyeras Boseyery Charge	_F = 35 A, di/dt = 100 A/µs		Q1		39	63	nC
Q _{rr}	Reverse Recovery Charge			Q2		39	63	nc

NOTES:

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design.



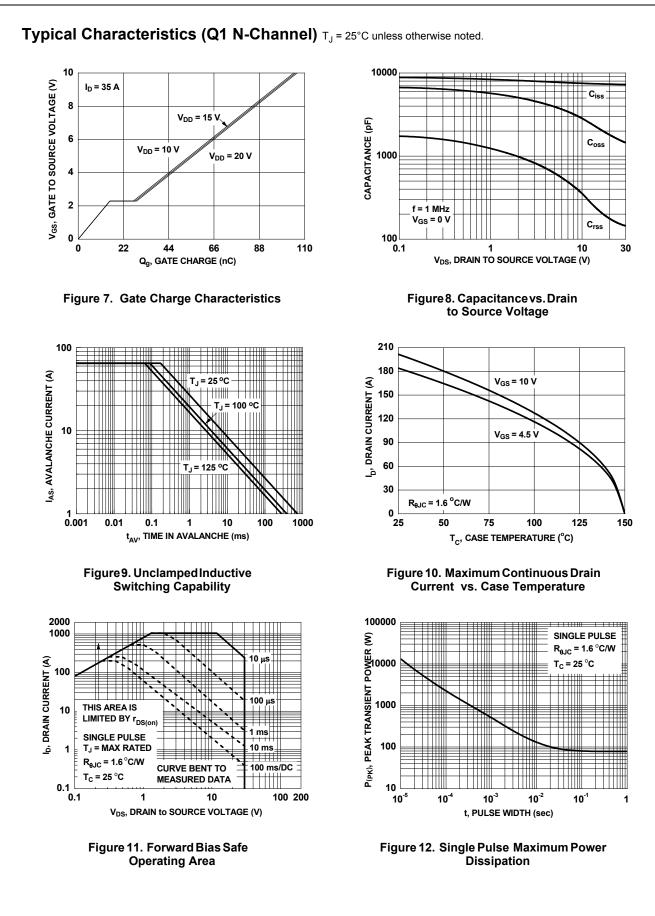
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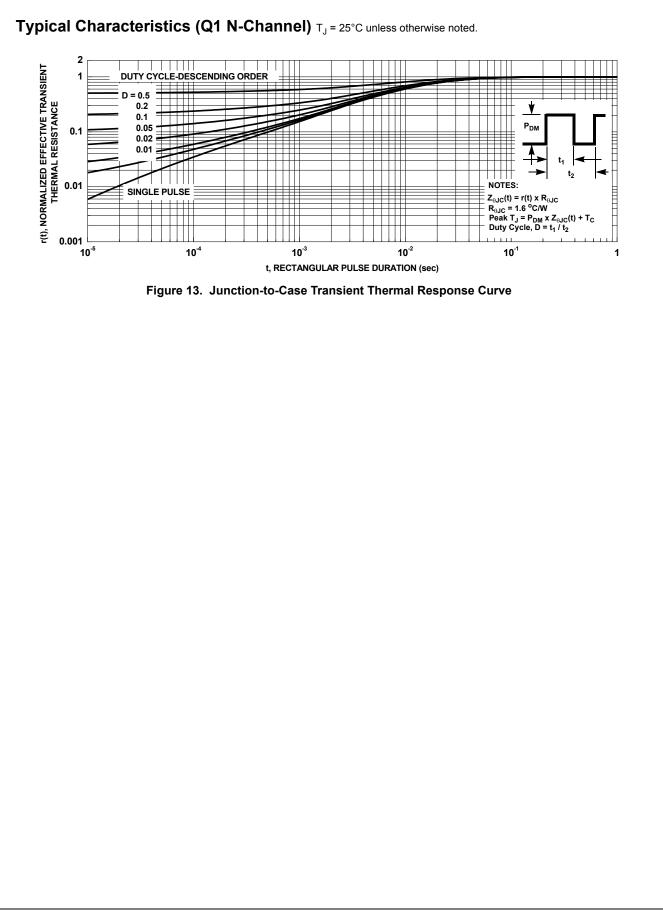


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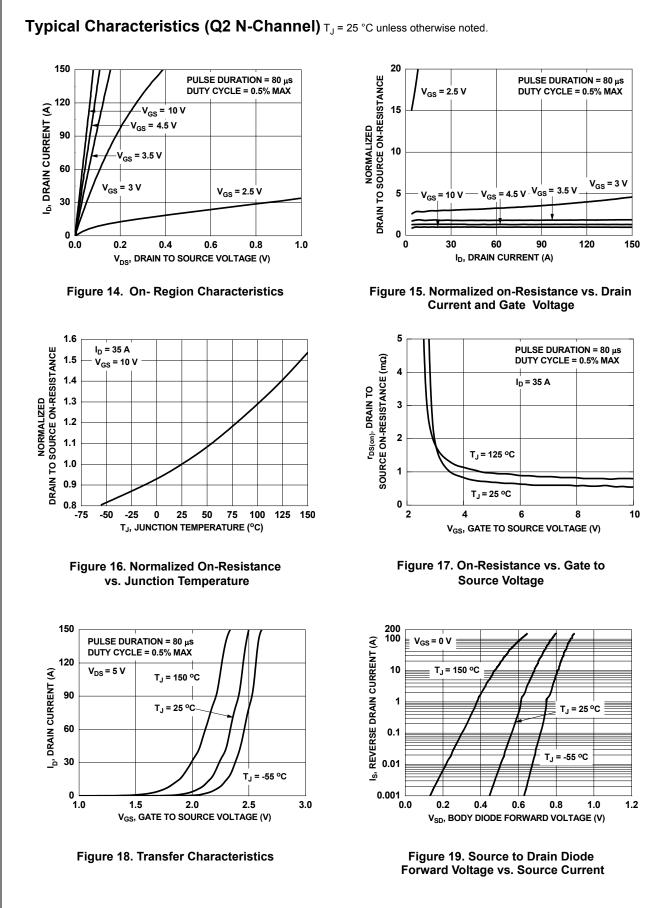
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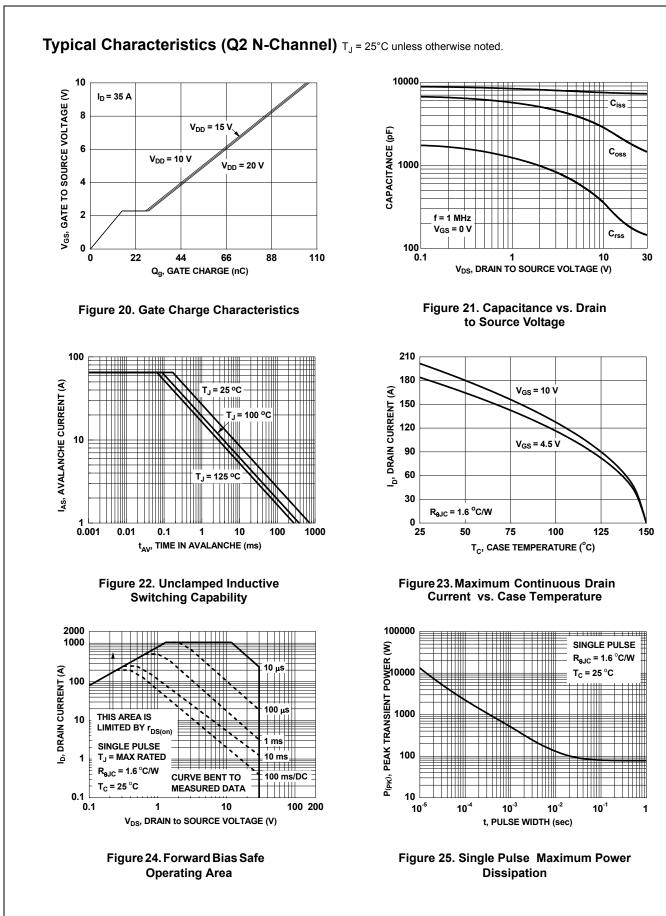




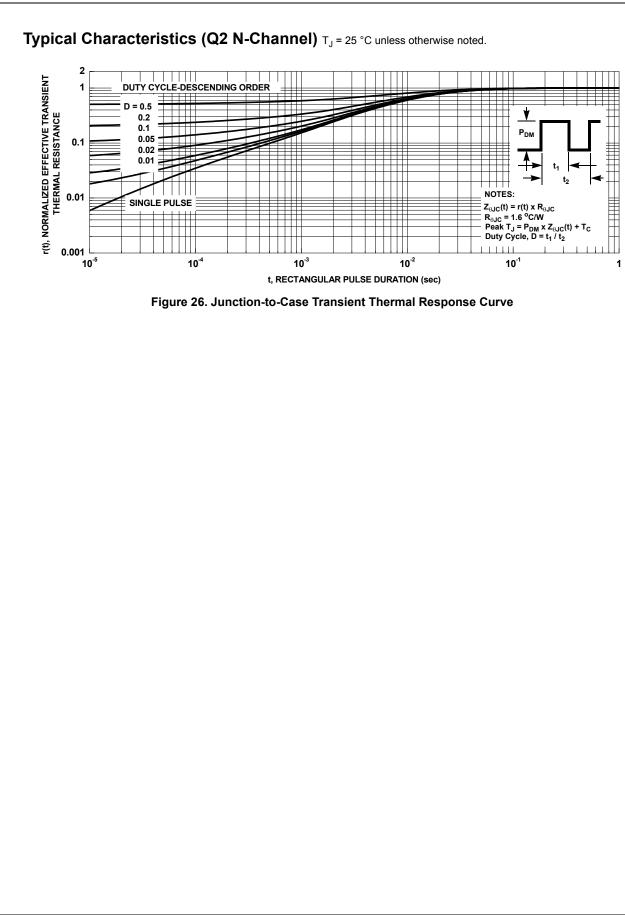
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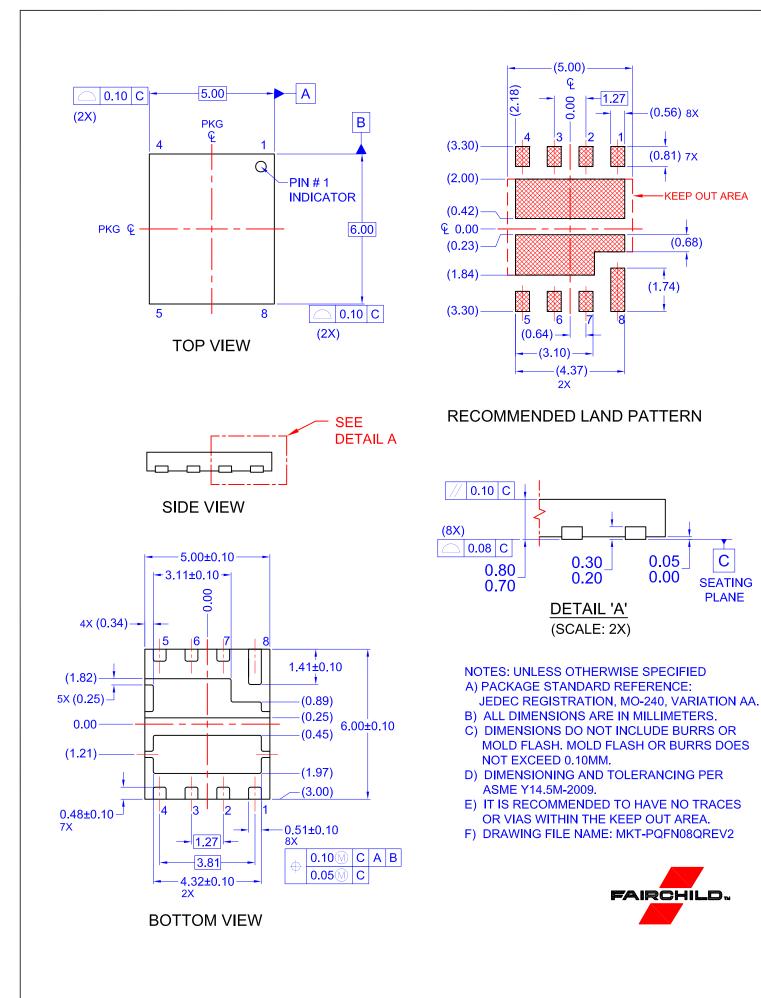












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